

AMENDMENT AND RESPONSE TO OFFICE ACTION DATED APRIL 24, 2002

Commissioner for Patents 2900 Crystal Drive Arlington, Virginia 22202-3513

Dear Sir:

In response to the Examiner's further office action of April 24, 2002, it is requested that the application be amended as follows:

In the Claims:

Amend Claim 4 as follows:

- 4. (Twice Amended). A printed circuit board comprising:
 - a) a plurality of spaced apart circuit layers;
 - b) a drill or laser formed blind hole/via extending between a surface circuit layer and at least one other circuit layer, said blind hole/via having an

electrical connect layer which electrically connects said surface circuit layer to said at least one other circuit layer;

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- c) a reflow pad for mounting a component to the surface circuit layer, said reflow pad extending over a surface part of said electrical connect layer, and also extending over the blind hole/via; and
- d) an electro-conductive material filling the blind hole/via.

Cancel Claims 6 and 8 without prejudice, as the subject matter of those claims has been incorporated into amended Claim 4.

Cancel Claim 7 without prejudice as it is incompatible with amended Claim 4.

Remarks

Reconsideration of the application is requested in view of the amendments above and the comments which follow.

The Examiner has indicated the allowability of the subject matter of Claim 8. Accordingly, Claim 4 has been amended to incorporate that novel subject matter (and Claim 6). Claim 5 remains in its present form, and Claims 6 and 8 have been cancelled in view of the incorporation into Claim 4. Finally, Claim 7 has been deleted since it is incompatible with Claim 4, as amended. Claims 4 and 5 remain in the application.

Given the incorporation of the allowable subject matter of Claim 8 into independent Claim 4, it is submitted that this application is now fully in condition for allowance, and the Examiner's further and favorable reconsideration in that regard is urged.

Respectfully submitted,

Date: May 31, 2002

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